

June 2007

# FSA2270 / FSA2270T Low-Voltage, Dual-SPDT (0.4 $\Omega$ ) Analog Switch with Negative Swing Audio Capability

#### Features

- 0.4Ω Typical On Resistance (R<sub>ON</sub>) for +3.0V Supply
- 0.25Ω Maximum R<sub>ON</sub> Flatness for +3.0V Supply
- -3db Bandwidth: > 50MHz
- Low-I<sub>CCT</sub> Current Over Expanded Control Input Range
- Packaged in Pb-free, 10-Lead UMLP
- Power-Off Protection on Common Ports
- Broad V<sub>CC</sub> Operating Range: 1.65 to 4.3V
- Noise Immunity Termination Resistors in FSA2270T
- Low Electrostatic Discharge (ESD)
  - Human Body Model (JEDEC: JESD22-A114)
    - Power to GND 16kv
  - I/O to GND 11kv
  - All other pins
    8kv
  - Charged Device Model (JEDEC: JESD22-A101)

### Applications

- Cell Phone, PDA, Digital Camera, and Notebook
- LCD Monitor, TV, and Set-Top Box

**Ordering Information** 

### Description

The FSA2270 is a high-performance, dual Single-Pole Double-Throw (SPDT) analog switch with negative swing audio capability. The FSA2270 features ultra-low  $R_{ON}$  of 0.4 $\Omega$  (typical) at 3.0V V<sub>CC</sub>. The FSA2270 operates over a wide V<sub>CC</sub> range of 1.65V to 4.3V, is fabricated with submicron CMOS technology to achieve fast switching speeds, and is designed for break-before-make operation. The select input is TTL-level compatible.

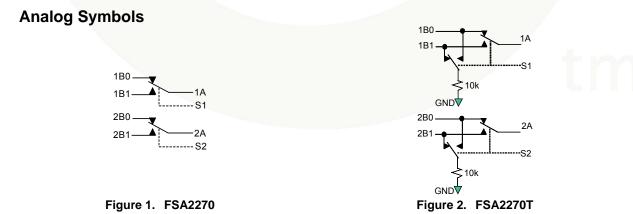
The FSA2270 features very low quiescent current even when the control voltage is lower than the  $V_{CC}$  supply. This feature suits mobile handset applications by allowing direct interface with baseband processor general-purpose I/Os with minimal battery consumption.

The FSA2270T includes termination resistors that improve noise immunity during overshoot excursions, off-isolation coupling, or "pop-minimization."

### **IMPORTANT NOTE:**

For additional performance information, please contact analogswitch@fairchildsemi.com.

ordering information			
Part Number	Top Mark	Pb-Free	Package Description
FSA2270UMX (Preliminary)	HJ	Yes	10-Lead, Quad Ultrathin Molded Leadless Package (UMLP), 1.4 x 1.8mm, 0.4mm pitch
FSA2270TUMX	HK	Yes	10-Lead, Quad Ultrathin Molded Leadless Package (UMLP), 1.4 x 1.8mm, 0.4mm pitch



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Definition of Terms

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